CMOS Low-Power Monostable/Astable Multivibrator

The RCA-CD4047A consists of a gatable astable multivibrator with logic techniques incorporated to permit positive or negative edge-triggered monostable multivibrator action with retriggering and external counting options.

Inputs include +TRIGGER, −TRIGGER, ASTABLE, $\overline{\text{ASTABLE}}$, RETRIGGER, and EXTERNAL RESET. Buffered outputs are Q, $\overline{Q}$, and OSCILLATOR. In all modes of operation an external capacitor must be connected between C-Timing and RC-Common terminals, and an external resistor must be connected between the R-Timing and RC-Common terminals.

Astable operation is enabled by a high level on the ASTABLE input. The period of the square wave at the Q and $\overline{Q}$ Outputs in this mode of operation is a function of the external components employed. "True" input pulses on the ASTABLE input or "Complement" pulses on the $\overline{\text{ASTABLE}}$ input allow the circuit to be used as a gatable multivibrator. The OSCILLATOR output period will be half of the Q terminal output in the astable mode. However, a 50% duty cycle is not guaranteed at this output.

In the monostable mode, positive-edge triggering is accomplished by application of a leading-edge pulse to the +TRIGGER input and a low level to the −TRIGGER input. For negative-edge triggering, a trailing-edge pulse is applied to the −TRIGGER and a high level is applied to the +TRIGGER. Input pulses may be of any duration relative to the output pulse. The multivibrator can be retriggered (on the leading edge only) by applying a common pulse to both the RETRIGGER and +TRIGGER inputs. In this mode the output pulse remains high as long as the RETRIGGER input is high, with or without transitions.

An external countdown option can be implemented by coupling "Q" to an external "N" counter and resetting the counter with the trigger pulse. The counter output pulse is fed back to the $\overline{\text{ASTABLE}}$ input and has a duration equal to N times the period of the multivibrator.

A high level on the EXTERNAL RESET input assures no output pulse during an "ON" power condition. This input can also be activated to terminate the output pulse at any time. In the monostable mode, a high-level or power-on reset pulse, must be applied to the EXTERNAL RESET whenever V_{DD} is applied.

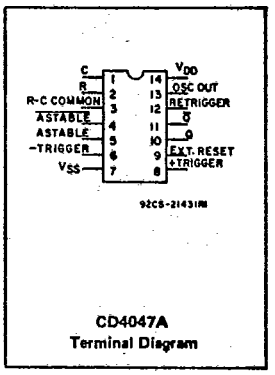
These types are supplied in 14-lead hermetic dual-in-line ceramic packages (D and F suffixes), 14-lead dual-in-line plastic packages (E suffix), 14-lead ceramic flat packages (K suffix), and in chip form (H suffix).

Features:

- Low power consumption: special COS/MOS oscillator configuration
- Monostable (one-shot) or astable (free-running) operation
- True and complemented buffered outputs
- Only one external R and C required
- Quiescent current specified to 15 V
- Maximum input leakage current of 1 μA at 15 V (full package-temperature range)
- 1-V noise margin (full package-temperature range)

Monostable Multivibrator Features:

- Positive- or negative-edge trigger
- Output pulse width independent of trigger pulse duration
- Retriggerable option for pulse width expansion
- Long pulse widths possible using small RC components by means of external counter provision
- Fast recovery time essentially independent of pulse width
- Pulse-width accuracy maintained at duty cycles approaching 100%



CD4047A
Terminal Diagram

Astable Multivibrator Features:

- Free-running or gatable operating modes
- 50% duty cycle
- Oscillator output available
- Good astable frequency stability:
  Frequency deviation:
  =±2% + 0.03%/°C @ 100 kHz
  =±0.5% + 0.015%/°C @ 10 kHz
  (circuits "trimmed" to frequency V_{DD} = 10 V ± 10%)

Applications :

Digital equipment where low-power dissipation and/or high noise immunity are primary design requirements:

- Envelope detection
- Frequency multiplication
- Frequency division
- Frequency discriminators
- Timing circuits
- Time-delay applications

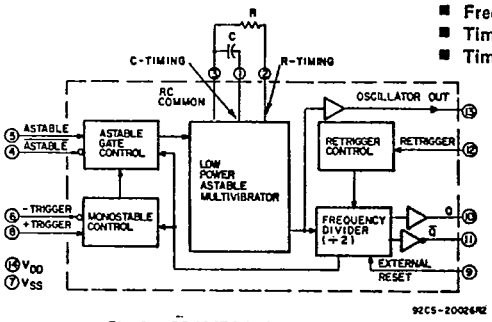


Fig. 1 – CD4047A logic block diagram.

MAXIMUM RATINGS, *Absolute-Maximum Values:*

STORAGE-TEMPERATURE RANGE (T_{stg}) . . . . . −65 to +150°C

OPERATING-TEMPERATURE RANGE (T_A):

PACKAGE TYPES D, F, K, H . . . . . −55 to +125°C

PACKAGE TYPE E . . . . . −40 to +85°C

DC SUPPLY-VOLTAGE RANGE, (V_{DD})

(Voltages referenced to V_{SS} Terminal): . . . . . −0.5 to +15 V

POWER DISSIPATION PER PACKAGE (P_D)

FOR T_A = −40 to +60°C (PACKAGE TYPE E) . . . . . 500 mW

FOR T_A = +60 to +85°C (PACKAGE TYPE E) . . . . . Derate Linearly at 12 mW/°C to 200 mW

FOR T_A = −55 to +100°C (PACKAGE TYPES D, F, K) . . . . . 500 mW

FOR T_A = +100 to +125°C (PACKAGE TYPES D, F, K) . . . . . Derate Linearly at 12 mW/°C to 200 mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR T_A = FULL PACKAGE-TEMPERATURE RANGE (ALL PACKAGE TYPES) . . . . . 100 mW

INPUT VOLTAGE RANGE, ALL INPUTS . . . . . −0.5 to V_{DD} +0.5 V

LEAD TEMPERATURE (DURING SOLDERING):

At distance 1/16 ±1/32 inch (1.59 ±0.79 mm) from case for 10 s max . . . . . +265°C

CD4047A Types

RECOMMENDED OPERATING CONDITIONS at T_A = 25°C, Except as Noted.
For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges:

CHARACTERISTIC	V_{DD}	LIMITS				UNITS
		D, F, K, H Packages		*E Package*		
		Min.	Max.	Min.	Max.	
Supply-Voltage Range (For T_A=Full Package- Temperature Range)		3	12	3	12	V
Input Pulse Width, t_W (Any Input)	5 10	1000 400	– –	1300 600	– –	ns
Trigger, Retrigger Rise or Fall Time, t_r, t_f	5 10	– –	15 5	– –	15 5	μs

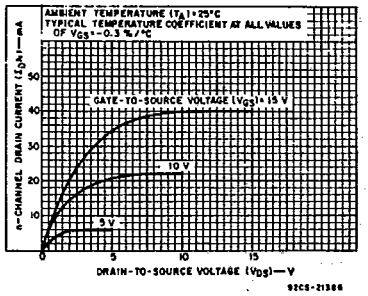


Fig. 2 – Typical output n-channel drain characteristics for Q and $\overline{Q}$ buffers.

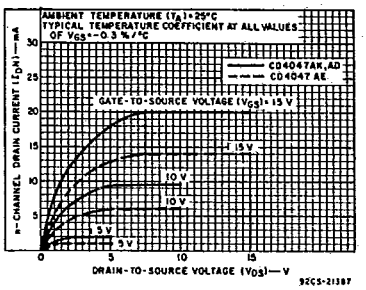


Fig. 3 – Minimum output n-channel drain characteristics for Q and $\overline{Q}$ buffers.

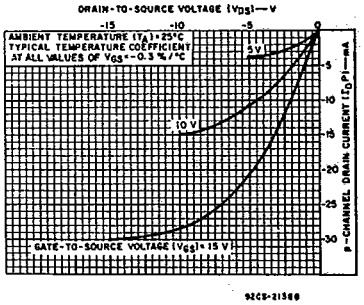


Fig. 4. – Typical output p-channel drain characteristics for Q and $\overline{Q}$ buffers.

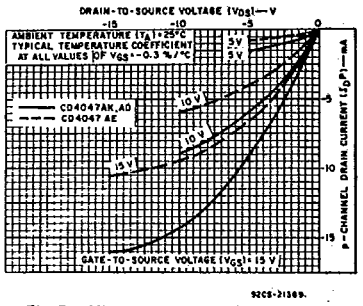


Fig. 5 – Minimum output p-channel drain characteristics for Q and $\overline{Q}$ buffers.

STATIC ELECTRICAL CHARACTERISTICS

Characteristics	Conditions			Limits at Indicated Temperatures (°C)								Units
				D, F, K, H Packages				*E Package*				
	V_O (V)	V_{IN} (V)	V_{DD} (V)	–55	+25 Typ.	+25 Limit	+125	- 40	+25 Typ.	+25 Limit	+85	
Quiescent Device Current I_L Max.	–	–	5	5	0.03	5	300	50	0.1	50	700	μA
	–	–	10	10	0.05	10	600	100	0.2	100	1400	
	–	–	15	50	1	50	2000	500	5	500	5000	
Output Voltage: Low-Level, V_{OL}	–	5	5	0 Typ.; 0.05 Max.								V
	–	10	10	0 Typ.; 0.05 Max.								
High Level V_{OH}	–	0	5	4.95 Min.; 5 Typ.								
	–	0	10	9.95 Min., 10 Typ.								
Noise Immunity: Inputs Low, V_{NL}	4.2	–	5	1.5 Min.; 2.25 Typ.								V
	9	–	10	3 Min.; 4.5 Typ.								
Inputs High V_{NH}	0.8	–	5	1.5 Min.; 2.25 Typ.								
	1	–	10	3 Min., 4.5 Typ.								
Noise Margin: Inputs Low, V_{NML}	4.5		5	1 Min.								V
	9		10	1 Min.								
Inputs High, V_{NMH}	0.5		5	1 Min.								
	1		10	1 Min.								
Output Drive Current: (Q,$\overline{Q}$ Outputs) n-channel (Sink), I_{DN} Min.	0.5	–	5	0.5	0.8	0.4	0.28	0.34	0.8	0.28	0.23	mA
	0.5	–	10	1.25	2	1	0.7	0.85	2	0.7	0.6	
p-Channel (Source): I_{DP} Min.	4.5	–	5	-0.5	-0.8	-0.4	-0.28	-0.34	-0.8	-0.28	-0.23	
	9.5	–	10	-1.25	-2	-1	-0.7	-0.85	-2	-0.7	-0.6	
Input Leakage Current, I_{IL},I_{IH}	Any Input	–	15	$\pm 10^{-5}$ Typ., ±1 Max.								μA

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25°C$, Input t_r, $t_f = 20$ ns, $C_L = 15$ pF, $R_L = 200$ kΩ

CHARACTERISTICS	TEST CONDITIONS	LIMITS						UNITS
		D, F, K, H Packages			E Package			
	V_{DD} (Volts)	Min.	TYP.	MAX.	MIN.	TYP.	MAX.	
Propagation Delay Time: t_{PHL}, t_{PLH} Astable, $\overline{\text{Astable}}$ to Osc. Out	5	–	200	400	–	200	550	ns
	10	–	100	200	–	100	275	
Astable, $\overline{\text{Astable}}$ to Q, $\overline{Q}$	5	–	550	900	–	550	1200	
	10	–	250	500	–	250	650	
+Trigger, –Trigger to Q, $\overline{Q}$	5	–	700	1200	–	700	1600	
	10	–	300	600	–	300	800	
+Trigger, Retrigger to Q, $\overline{Q}$	5	–	300	600	–	300	800	
	10	–	175	300	–	175	400	
External Reset to Q, $\overline{Q}$	5	–	300	600	–	300	800	
	10	–	125	250	–	125	350	
Transition Time: t_{THL}, t_{TLH} Q, $\overline{Q}$	5	–	75	125	–	75	150	ns
	10	–	45	75	–	45	100	
Osc. Out	5	–	75	150	–	75	180	
	10	–	45	100	–	45	130	
Minimum Input Pulse Width (any input), t_W*	5	–	500	1000	–	500	1300	ns
	10	–	200	400	–	200	600	
+Trigger, Retrigger Rise & Fall Time, t_r, t_f	5	–	–	15	–	–	15	μs
	10	–	–	5	–	–	5	
Average Input Capacitance, C_I	Any Input	–	–	5	–	–	5	–	pF

* Input pulse widths below the minimum specified may cause malfunction of the unit. See Application Note ICAN-6230

CD4047A FUNCTIONAL TERMINAL CONNECTIONS
NOTE: IN ALL CASES EXTERNAL RESISTOR BETWEEN TERMINALS 2 AND 3▲
EXTERNAL CAPACITOR BETWEEN TERMINALS 1 AND 3▲

FUNCTION	TERMINAL CONNECTIONS			OUTPUT PULSE FROM	OUTPUT PERIOD OR PULSE WIDTH
	TO V_{DD}	TO V_{SS}	INPUT PULSE TO		
Astable Multivibrator:					
Free Running	4,5,6,14	7,8,9,12	–	10,11,13	$t_A(10,11)=4.40$ RC
True Gating	4,6,14	7,8,9,12	5	10,11,13	$t_A(13)=2.20$ RC
Complement Gating	6,14	5,7,8,9,12	4	10,11,13	
Monostable Multivibrator:					
Positive-Edge Trigger	4,14	5,6,7,9,12	8	10,11	$t_M(10,11)=2.48$ RC
Negative-Edge Trigger	4,8,14	5,7,9,12	6	10,11	
Retriggerable	4,14	5,6,7,9	8,12	10,11	
External Countdown*	14	5,6,7,8,9,12	–	10,11	

* Input Pulse to Reset of External Counting Chip External Counting Chip Output To Terminal 4 ▲ See Text.

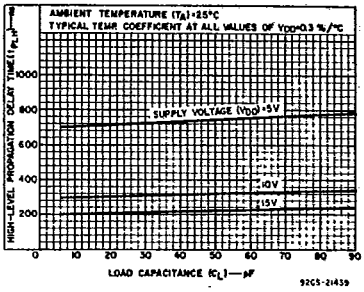


Fig. 6 – Typical low-to-high level propagation delay time vs load capacitance for Q and $\overline{Q}$ buffers.

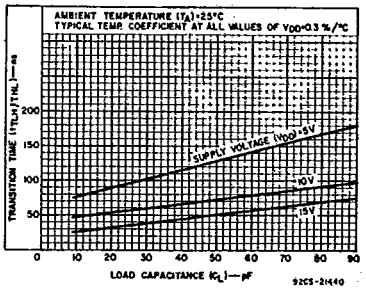


Fig. 7 – Typical transition time vs load capacitance for Q and $\overline{Q}$ buffers.

I. Astable Mode Design Information

A. Unit-to-Unit Transfer-Voltage Variations.

The following analysis presents worst-case variations from unit to unit as a function of transfer-voltage (V_{TR}) shift (33%–67% V_{DD}) for free-running (astable) operation.

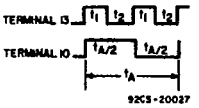


Fig. 8 – Astable mode waveforms.

$$t_1 = -RC \ln \frac{V_{TR}}{V_{DD} + V_{TR}}$$

$$t_2 = -RC \ln \frac{V_{DD} - V_{TR}}{2V_{DD} - V_{TR}}$$

$$t_A = 2(t_1 + t_2)$$

$$= -2\,RC \ln \frac{(V_{TR})(V_{DD} - V_{TR})}{(V_{DD} + V_{TR})(2V_{DD} - V_{TR})}$$

Typ: $V_{TR} = 0.5\,V_{DD}$ $t_A = 4.40$ RC
Min: $V_{TR} = 0.33\,V_{DD}$ $t_A = 4.62$ RC
Max: $V_{TR} = 0.67\,V_{DD}$ $t_A = 4.62$ RC

thus if $\boxed{t_A = 4.40\,RC}$ is used, the maximum variation will be (+5.0%,–0.0%).

CD4047A Types

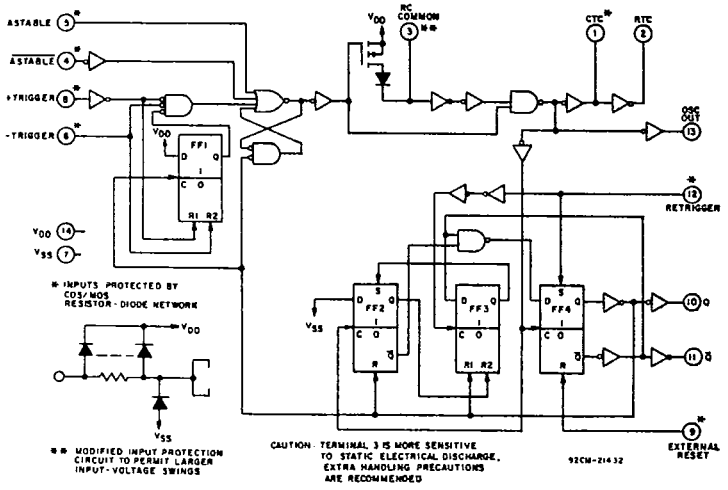


Fig. 9 – CD4047A logic diagram.

B. Variations Due to V_{DD} and Temperature Changes

In addition to variations from unit to unit, the astable period may vary as a function of frequency with respect to V_{DD} and temperature. Typical variations are presented in graphical form in Figs. 10 to 20 with 10 V as reference for voltage variation curves and 25°C as reference for temperature variation curves.

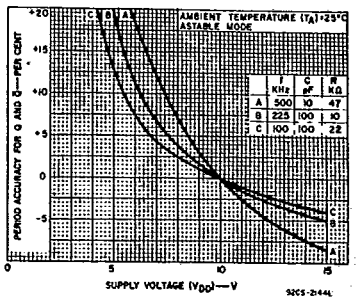


Fig. 10 – Typical Q-and-$\overline{Q}$-period accuracy vs supply voltage (high frequency).

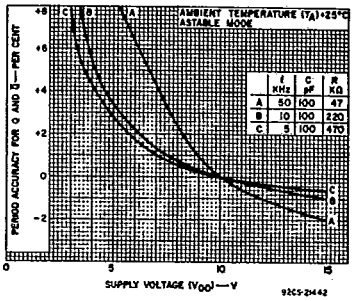


Fig. 11 – Typical Q-and-$\overline{Q}$-period accuracy vs supply voltage (medium frequency).

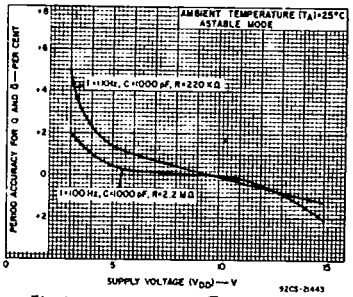


Fig. 12 – Typical Q-and-$\overline{Q}$-period accuracy vs supply voltage (low frequency).

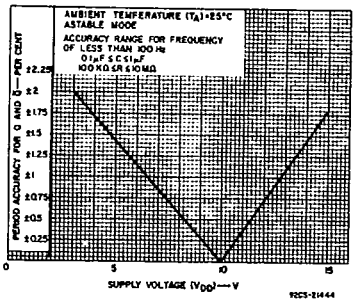


Fig. 13 – Typical Q-and-$\overline{Q}$- period accuracy vs supply voltage (very low frequency).

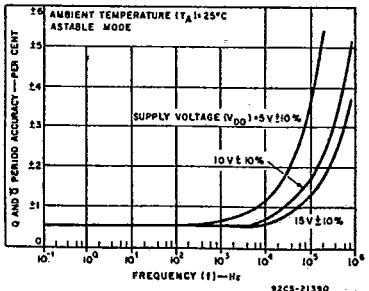


Fig. 14 – Typical Q-and-$\overline{Q}$-period accuracy vs frequency for V_{DD} variation of ±10% from value indicated.

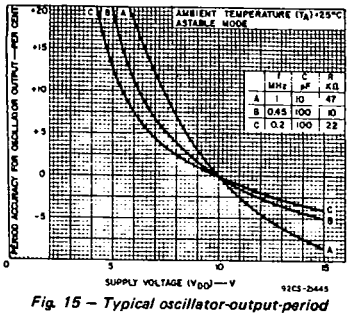


Fig. 15 – Typical oscillator-output-period accuracy vs supply voltage (high frequency).

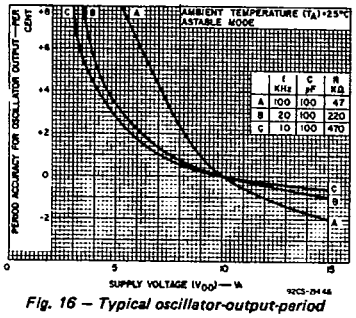


Fig. 16 – Typical oscillator-output-period accuracy vs supply voltage (medium frequency).

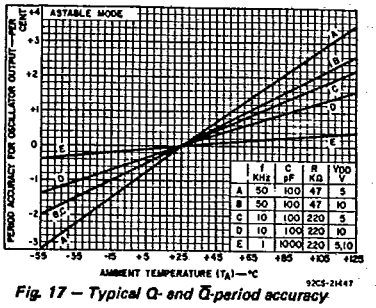


Fig. 17 – Typical Q- and $\overline{Q}$-period accuracy vs temperature (medium frequency).

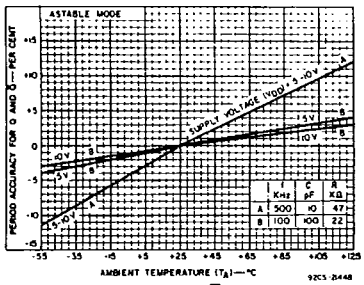


Fig. 18 – Typical Q- and Q̄-period accuracy vs temperature (high frequency).

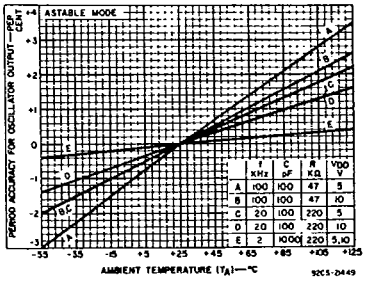


Fig. 19 – Typical oscillator-period accuracy vs temperature (medium frequency).

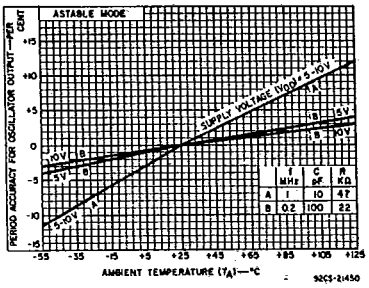


Fig. 20 – Typical oscillator-period accuracy vs temperature (high frequency).

II. Monostable Mode Design Information

The following analysis presents worst-case variations from unit to unit as a function of transfer-voltage (V_{TR}) shift (33% – 67% V_{DD}) for one-shot (monostable) operation.

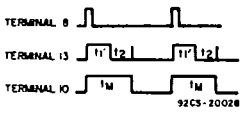


Fig. 21 – Monostable waveforms.

$$t_1' = -RC \ln \frac{V_{TR}}{2V_{DD}}$$

$$t_M = (t_1' + t_2)$$

$$t_M = -RC \ln \frac{(V_{TR})(V_{DD} - V_{TR})}{(2V_{DD} - V_{TR})(2V_{DD})}$$

where t_M = Monostable mode pulse width. Values for t_M are as follows:

Typ: $V_{TR} = 0.5\ V_{DD}$ $t_M = 2.48\ RC$
Min: $V_{TR} = 0.33\ V_{DD}$ $t_M = 2.71\ RC$
Max. $V_{TR} = 0.67\ V_{DD}$ $t_M = 2.48\ RC$

Thus if $\boxed{t_M = 2.48\ RC}$ is used, the maximum variation will be (+9.3%, –0.0%).

Note:
In the astable mode, the first positive half cycle has a duration of T_M; succeeding durations are $t_A/2$.

In addition to variations from unit to unit, the monostable pulse width may vary as a function of frequency with respect to V_{DD} and temperature. These variations are presented in graphical form in Fig. 22 to 27 with 10 V as reference for voltage-variation curves and 25°C as reference for temperature-variation curves.

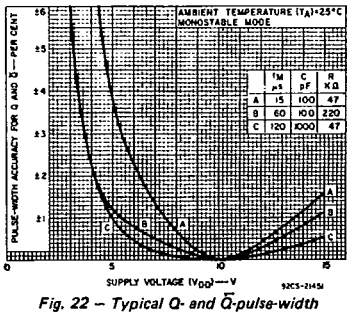


Fig. 22 – Typical Q- and Q̄-pulse-width accuracy vs supply voltage (t_M = 15, 60, 120 µs).

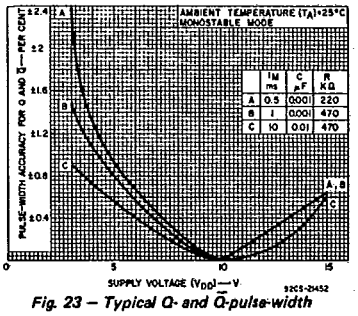


Fig. 23 – Typical Q- and Q̄-pulse-width accuracy vs supply voltage (t_M = 0.5, 1, 10 ms).

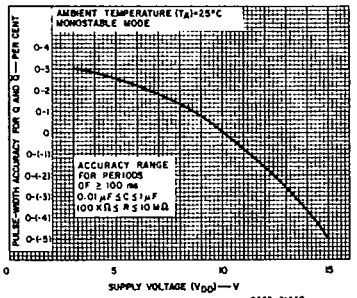


Fig. 24 – Typical Q- and Q̄-pulse-width accuracy vs supply voltage ($t_M \geq$ 100 ms).

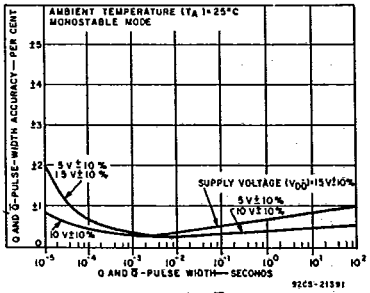


Fig. 25 – Typical Q- and Q̄ pulse-width accuracy vs Q and Q̄ pulse width for a variation of ±10% from value indicated.

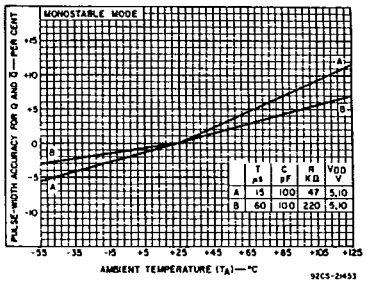


Fig. 26 – Typical Q and Q̄ pulse-width accuracy vs temperature (high frequency).

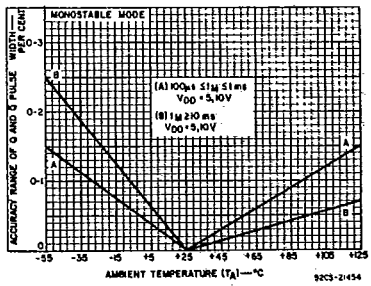


Fig. 27 – Typical Q and Q̄ pulse-width accuracy range vs temperature.

CD4047A Types

III. Retrigger Mode Operation

The CD4047A can be used in the retrigger mode to extend the output-pulse duration, or to compare the frequency of an input signal with that of the internal oscillator. In the retrigger mode the input pulse is applied to terminals 8 and 12, and the output is taken from terminal 10 or 11. As shown in Fig. 28, normal monostable action is obtained when one retrigger pulse is applied. Extended pulse duration is obtained when more than one pulse is applied. For two input pulses, $t_{RE}=t_1' + t_1 + 2t_2$. For more than two pulses, t_{RE} (Q OUTPUT), terminates at some variable time, t_D, after the termination of the last retrigger pulse, t_D is variable because t_{RE} (Q OUTPUT) terminates after the second positive edge of the oscillator output appears at flip-flop 4 (see Fig. 8).

IV. External Counter Option

Time t_M can be extended by any amount with the use of external counting circuitry. Advantages include digitally controlled pulse duration, small timing capacitors for long time periods, and extremely fast recovery time. A typical implementation is shown in Fig. 29. The pulse duration at the output is

$$t_{ext} = (N-1)(t_A) + (t_M + t_A/2)$$

where t_{ext}= pulse duration of the circuitry, and N is the number of counts used.

V. Timing-Component Limitations

The capacitor used in the circuit should be non-polarized and have low leakage(i.e. the parallel resistance of the capacitor should be an order of magnitude greater than the external resistor used). There is no upper or lower limit for either R or C value to maintain oscillation.

However, in consideration of accuracy, C must be much larger than the inherent stray capacitance in the system (unless this capacitance can be measured and taken into account). R must be much larger than the CMOS "ON" resistance in series with it, which typically is hundreds of ohms. In addition, with very large values of R, some short-term instability with respect to time may be noted.

The recommended values for these components to maintain agreement with previously calculated formulas without trimming should be:

$C \geqslant 100$ pF, up to any practical value, for astable modes;

$C \geqslant 1000$ pF, up to any practical value for monostable modes.

$10\ k\Omega \leqslant R \leqslant 1\ M\Omega$

VI. Power Consumption

In the standby mode (Monostable or Astable), power dissipation will be a function of leakage current in the circuit, as shown in the static electrical characteristics. For dynamic operation, the power needed to charge the external timing capacitor C is given by the following formulae:

Astable Mode: $P = 2CV^2f$. (Output at terminal No. 13)
$P = 4CV^2f$. (Output at terminal Nos. 10 and 11)

Monostable Mode:

$$P = \frac{(2.9CV^2)\ (\text{Duty Cycle})}{T}$$

(Output at terminal Nos. 10 and 11)

The circuit is designed so that most of the total power is consumed in the external components. In practice, the lower the values of frequency and voltage used, the closer the actual power dissipation will be to the calculated value.

Because the power dissipation does not depend on R, a design for minimum power dissipation would be a small value of C. The value of R would depend on the desired period (within the limitations discussed above). See Figs. 30–32 for typical power consumption in astable mode.

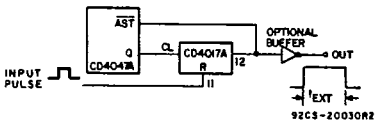


Fig. 28 – Implementation of external counter option.

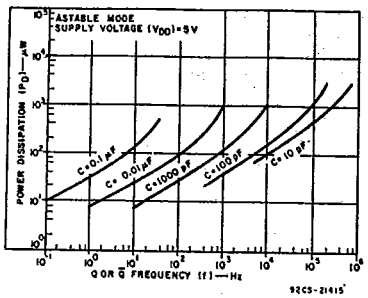


Fig. 30 – Power dissipation vs output frequency (V_{DD} = 5 V).

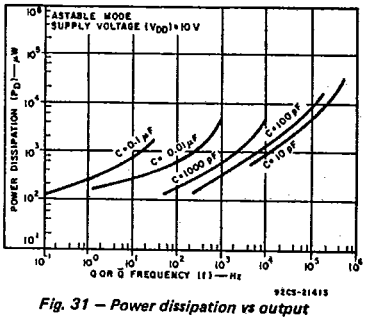


Fig. 31 – Power dissipation vs output frequency (V_{DD} = 10 V).

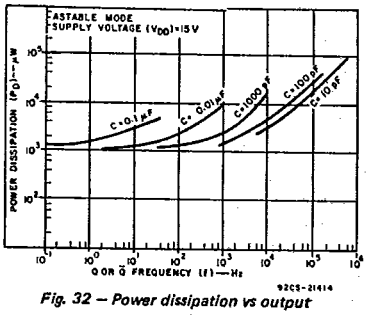


Fig. 32 – Power dissipation vs output frequency (V_{DD} = 15 V).

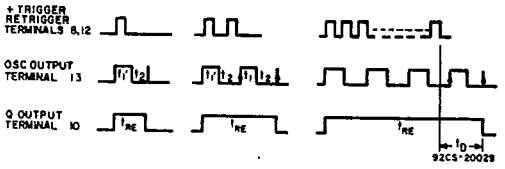
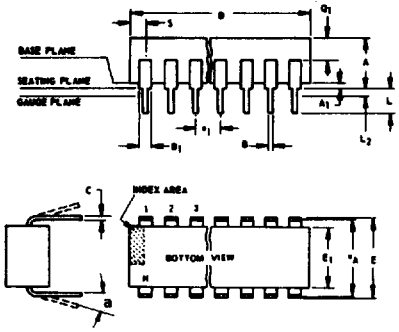


Fig. 29 – Retrigger-mode waveforms.

Dimensional Outlines

Dual-In-Line Welded-Seal Ceramic Packages



NOTES:
Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
1. When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
3. e_A applies in zone L_2 when unit installed.
4. α applies to spread leads prior to installation.
5. N is the maximum quantity of lead positions.
6. N_1 is the quantity of allowable missing leads.

(D) SUFFIX (JEDEC MO-001-AD)
14-Lead Dual-In-Line Welded-Seal Ceramic Package

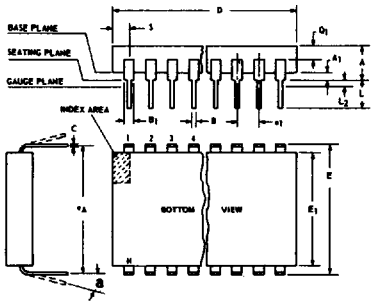
SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.160		3.05	4.06
A_1	0.020	0.065		0.51	1.65
B	0.014	0.020		0.356	0.508
B_1	0.050	0.065		1.27	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.770		18.93	19.55
E	0.300	0.325		7.62	8.25
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L_2	0.000	0.030		0.000	0.76
α	0°	15°	4	0°	15°
N	14		5	14	
N_1	0		6	0	
Q_1	0.050	0.085		1.27	2.15
S	0.065	0.090		1.66	2.28

92SS-4411R2

(D) SUFFIX (JEDEC MO-001-AE)
16-Lead Dual-In-Line Welded-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.160		3.05	4.06
A_1	0.020	0.065		0.51	1.65
B	0.014	0.020		0.356	0.508
B_1	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.785		18.93	19.93
E	0.300	0.325		7.62	8.25
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L_2	0.000	0.030		0.000	0.76
α	0°	15°	4	0°	15°
N	16		5	16	
N_1	0		6	0	
Q_1	0.050	0.085		1.27	2.15
S	0.015	0.060		0.39	1.52

92SS-4286R5



NOTES:
Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
1. When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
3. e_A applies in zone L_2 when unit installed.
4. α applies to spread leads prior to installation.
5. N is the maximum quantity of lead positions.
6. N_1 is the quantity of allowable missing leads.

(D) SUFFIX (JEDEC MO-015-AG)
24-Lead Dual-In-Line Welded-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.090	0.200		2.29	5.08
A_1	0.020	0.070		0.51	1.78
B	0.015	0.020		0.381	0.508
B_1	0.045	0.055		1.143	1.397
C	0.008	0.012	1	0.204	0.304
D	1.15	1.22		29.21	30.98
E	0.600	0.625		15.24	15.87
E_1	0.480	0.520		12.20	13.20
e_1	0.100 TP		2	2.54 TP	
e_A	0.600 TP		2,3	15.24 TP	
L	0.100	0.180		2.54	4.57
L_2	0.000	0.030		0.00	0.76
α	0°	15°	4	0°	15°
N	24		5	24	
N_1	0		6	0	
Q_1	0.020	0.080		0.51	2.03
S	0.020	0.060		0.51	1.52

92CS-19948R4

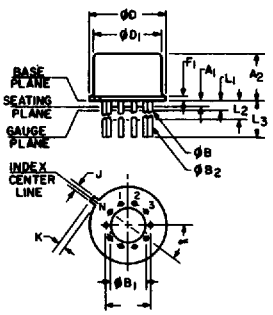
(D) SUFFIX (JEDEC MO-015-AH)
28-Lead Dual-In-Line Welded-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.090	0.200		2.29	5
A_1	0	0.070	2	0	1.77
B	0.015	0.020		0.381	0.508
B_1	0.015	0.055		0.39	1.39
C	0.008	0.012	1	0.204	0.304
D	1.380	1.420		35.06	36.06
E	0.600	0.625		15.24	15.87
E_1	0.485	0.515		12.32	13.08
e_1	0.100 TP		2	2.54 TP	
e_A	0.600 TP		2,3	15.24 TP	
L	0.100	0.200		2.8	5
L_2	0	0.030		0	0.76
α	0°	15°	4	0°	15°
N	28		5	28	
N_1	0		6	0	
Q_1	0.020	0.070		0.51	1.77
S	0.040	0.070		1.02	1.77

92CM-20250R2

TO-5 Style Package

(T) SUFFIX (JEDEC MO-006-AG)
12-Lead Metal Package



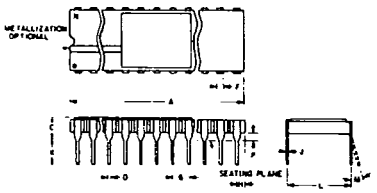
92CS-19774

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
a	0.230		2	5.84 TP	
A_1	0	0		0	0
A_2	0.165	0.185		4.19	4.70
ϕB	0.016	0.019	3	0.407	0.482
ϕB_1	0	0		0	0
ϕB_2	0.016	0.021	3	0.407	0.533
ϕD	0.335	0.370		8.51	9.39
ϕD_1	0.305	0.335		7.75	8.50
F_1	0.020	0.040		0.51	1.01
j	0.028	0.034		0.712	0.863
k	0.029	0.045	4	0.74	1.14
L_1	0.000	0.050	3	0.00	1.27
L_2	0.250	0.500	3	6.4	12.7
L_3	0.500	0.562	3	12.7	14.27
α	30° TP			30° TP	
N	12		6	12	
N_1	1		5	1	

NOTES:
1. Refer to Rules for Dimensioning Axial Lead Product Outlines.
2. Leads at gauge plane within 0.007" (0.178 mm) radius of True Position (TP) at maximum material condition.
3. ϕB applies between L_1 and L_2. ϕB_2 applies between L_2 and 0.500" (12.70 mm) from seating plane. Diameter is uncontrolled in L_1 and beyond 0.500" (12.70 mm).
4. Measure from Max. ϕD.
5. N_1 is the quantity of allowable missing leads.
6. N is the maximum quantity of lead positions.

Dimensional Outlines (Cont'd)

DUAL-IN-LINE SIDE-BRAZED CERAMIC PACKAGES



NOTES:
1. Leads within 0.005" (0.13 mm)-radius of True Position at maximum material condition.
2. Dimension "L" to center of leads when formed parallel.
3. When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).

(D) SUFFIX
18-Lead Dual-In-Line
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.890	0.915		22.606	23.241
C	–	0.200		–	5.080
D	0.015	0.021		0.381	0.533
F	0.054 REF.		1	1.371 REF.	
G	0.100 BSC		1	2.54 BSC	
H	0.035	0.065		0.889	1.651
J	0.008	0.012	3	0.203	0.304
K	0.125	0.150		3.175	3.810
L	0.290	0.310	2	7.366	7.874
M	0°	15°		0°	15°
P	0.025	0.045		0.635	1.143
N	18			18	

92CS-27231R1

(D) SUFFIX
22-Lead Dual-In-Line
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.065	1.100		27.05	27.94
C	0.085	0.145		2.16	3.68
D	0.017	0.023		0.43	0.58
F	0.040 REF.		1	1.02 REF.	
G	0.100 BSC		1	2.54 BSC	
H	0.030	0.070		0.76	1.78
J	0.008	0.012	3	0.20	0.30
K	0.125	0.175		3.18	4.45
L	0.380	0.420	2	9.65	10.67
M	–	7°		–	7°
P	0.025	0.050		0.64	1.27
N	22			22	

92CS-25186R2

(D) SUFFIX
24-Lead Dual-In-Line
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.180	1.220		29.98	30.98
C	0.085	0.145		2.16	3.68
D	0.015	0.023		0.39	0.58
F	0.040 REF.			1.02 REF.	
G	0.100 BSC		1	2.54 BSC	
H	0.030	0.070		0.77	1.77
J	0.008	0.012	3	0.21	0.30
K	0.125	0.175		3.18	4.44
L	0.580	0.620	2	14.74	15.74
M	–	7°		–	7°
P	0.025	0.050		0.64	1.27
N	24			24	

92CS-30986R1

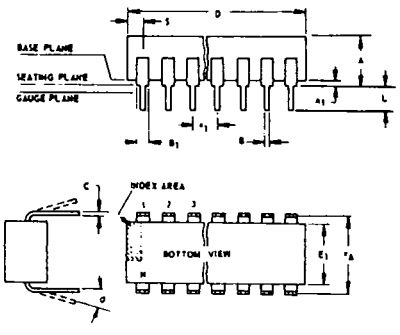
(D) SUFFIX
40-Lead Dual-In-Line
Side-Brazed Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	1.980	2.020		50.30	51.30
C	0.095	0.155		2.43	3.93
D	0.017	0.023		0.43	0.56
F	0.050 REF.			1.27 REF.	
G	0.100 BSC		1	2.54 BSC	
H	0.030	0.070		0.76	1.78
J	0.008	0.012	3	0.20	0.30
K	0.125	0.175		3.18	4.45
L	0.580	0.620	2	14.74	15.74
M	–	7°		–	7°
P	0.025	0.050		0.64	1.27
N	40			40	

92CM-27029R2

Dual-In-Line Plastic and Frit-Seal Ceramic Packages

(E) SUFFIX (JEDEC MO-001-AN)
8-Lead Dual-In-Line Plastic
(Mini-DIP) Package



SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A_1	0.020	0.050		0.508	1.27
B	0.014	0.020		0.356	0.508
B_1	0.035	0.065		0.889	1.65
C	0.008	0.012	1	0.203	0.304
D	0.370	0.400		9.40	10.16
E	0.300	0.325		7.62	8.25
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L_2	0.000	0.030		0.000	0.762
α	0	15	4	0	15
N	8		5	8	
N_1	0		6	0	
Q_1	0.040	0.075		1.02	1.90
S	0.015	0.060		0.381	1.52

92CS-24026R1

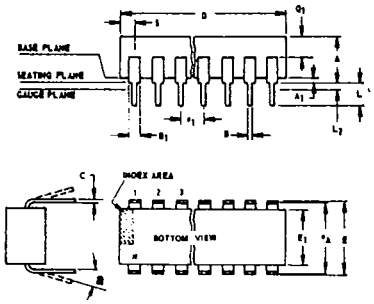
NOTES:

Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.

1. When this device is supplied solder-dipped, the maximum lead thickness (narrow portion) will not exceed 0.013".
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at guage plane with maximum material condition and unit installed.
3. e_A applies in zone L_2 when unit installed.
4. α applies to spread leads prior to installation.
5. N is the maximum quantity of lead positions.
6. N_1 is the quantity of allowable missing leads.

Dimensional Outlines (Cont'd)

Dual-In-Line Plastic and Frit-Seal Ceramic Packages (Cont'd)



NOTES:
Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
1. When this device is supplied solder dipped, the maximum lead thickness (narrow portion) will not exceed 0.013" (0.33 mm).
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at gauge plane with maximum material condition and unit installed.
3. e_A applies in zone L_2 when unit installed.
4. α applies to spread leads prior to installation.
5. N is the maximum quantity of lead positions.
6. N_1 is the quantity of allowable missing leads.

(E) and (F) SUFFIXES (JEDEC MO-001-AB)
14-Lead Dual-In-Line Plastic or Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A_1	0.020	0.060		0.51	1.27
B	0.014	0.020		0.356	0.508
B_1	0.050	0.065		1.27	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.770		18.93	19.55
E	0.300	0.325		7.62	8.25
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L_2	0.000	0.030		0.000	0.76
a	0°	15°	4	0°	15°
N	14		5	14	
N_1	0		6	0	
Q_1	0.040	0.075		1.02	1.90
S	0.065	0.090		1.66	2.28

92SS-4296R3

(E) and (F) SUFFIXES (JEDEC MO-001-AC)
16-Lead Dual-In-Line Plastic or Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A_1	0.020	0.050		0.51	1.27
B	0.014	0.020		0.356	0.508
B_1	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.745	0.785		18.93	19.93
E	0.300	0.325		7.62	8.25
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.125	0.150		3.18	3.81
L_2	0.000	0.030		0.000	0.76
a	0°	15°	4	0°	15°
N	16		5	16	
N_1	0		6	0	
Q_1	0.040	0.075		1.02	1.90
S	0.015	0.060		0.39	1.52

92CM-15967R4

(E) SUFFIX
18-Lead Dual-In-Line Plastic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A_1	0.020	0.050		0.508	1.27
B	0.014	0.020		0.356	0.508
B_1	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D	0.845	0.885		21.47	22.47
E_1	0.240	0.260		6.10	6.60
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2,3	7.62 TP	
L	0.125	0.150		3.18	3.81
a	0°	15°	4	0°	15°
N	18		5	18	
N_1	0		6	0	
S	0.015	0.060		0.39	1.52

92CS-30630

(E) SUFFIX
22-Lead Dual-In-Line Plastic Package

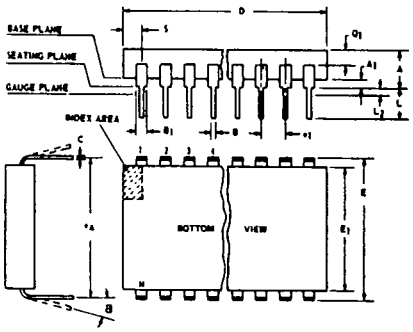
SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.155	0.200		3.94	5.08
A_1	0.020	0.050		0.508	1.27
B	0.015	0.020		0.381	0.508
B_1	0.035	0.065		0.89	1.65
C	0.008	0.012	1	0.204	0.304
D		1.120			28.44
E	0.390	0.420		9.91	10.66
E_1	0.345	0.355		8.77	9.01
e_1	0.100 TP		2	2.54 TP	
e_A	0.400 TP		2, 3	10.16 TP	
L	0.125	0.150		3.18	3.81
L_2	0	0.030		0	0.762
a	2°	15°	4	2°	15°
N	22		5	22	
N_1	0		6	0	
Q_1	0.055	0.085		1.40	2.15
S	0.015	0.060		0.381	1.27

92CS-30830

(F) SUFFIX (JEDEC MO-001-AG)
16-Lead Dual-In-Line Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.165	0.210		4.20	5.33
A_1	0.015	0.045		0.381	1.14
B	0.015	0.020		0.381	0.508
B_1	0.045	0.070		1.15	1.77
C	0.009	0.011	1	0.229	0.279
D	0.750	0.795		19.05	20.19
E	0.295	0.325		7.50	8.25
E_1	0.245	0.300		6.23	7.62
e_1	0.100 TP		2	2.54 TP	
e_A	0.300 TP		2, 3	7.62 TP	
L	0.120	0.160		3.05	4.06
L_2	0.000	0.030		0.000	0.76
a	2°	15°	4	2°	15°
N	16		5	16	
N_1	0		6	0	
Q_1	0.050	0.080		1.27	2.03
S	0.010	0.060		0.254	1.52

92CM-22284R1



NOTES:
Refer to Rules for Dimensioning (JEDEC Publication No. 95) for Axial Lead Product Outlines.
1. When this device is supplied solder dipped, the maximum lead thickness (narrow portion) will not exceed 0.013".
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at guage plane with maximum material condition and unit installed
3. e_A applies in zone L_2 when unit installed.
4. α applies to spread leads prior to installation.
5. N is the maximum quantity of lead positions.
6. N_1 is the quantity of allowable missing leads.

(E) and (F) SUFFIXES (JEDEC MO-015-AA)
24-Lead Dual-In-Line Plastic or Frit-Seal Ceramic Package

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.250		3.10	6.30
A_1	0.020	0.070		0.51	1.77
B	0.016	0.020		0.407	0.508
B_1	0.028	0.070		0.72	1.77
C	0.008	0.012	1	0.204	0.304
D	1.20	1.29		30.48	32.76
E	0.600	0.625		15.24	15.87
E_1	0.515	0.580		13.09	14.73
e_1	0.100 TP		2	2.54 TP	
e_A	0.600 TP		2,3	15.24 TP	
L	0.100	0.200		2.54	5.00
L_2	0.000	0.030		0.00	0.76
a	0°	15°	4	0°	15°
N	24		5	24	
N_1	0		6	0	
Q_1	0.040	0.075		1.02	1.90
S	0.040	0.100		1.02	2.54

92CS26938R2

(E) SUFFIX
40-Lead Dual-In-Line Plastic Package

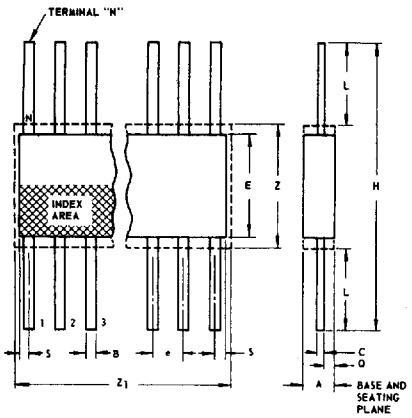
SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.120	0.250		3.10	6.30
A_1	0.020	0.070		0.51	1.77
B	0.016	0.020		0.407	0.508
B_1	0.028	0.070		0.72	1.77
C	0.008	0.012	1	0.204	0.304
D	2.000	2.090		50.80	53.09
E_1	0.515	0.580		13.09	14.73
e_1	0.100 TP		2	2.54 TP	
e_A	0.600 TP		2,3	15.24 TP	
L	0.100	0.200		2.54	5.00
L_2	0.000	0.030		0.00	0.76
a	0°	15°	4	0°	15°
N	40		5	40	
N_1	0		6	0	
Q_1	0.065	0.095		1.66	2.41
S	0.040	0.100		1.02	2.54

92CS-30959

Dimensional Outlines (Cont'd)

Ceramic Flat Packs

(K) SUFFIX (JEDEC MO-004-AF)
14-Lead



SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.008	0.100		0.21	2.54
B	0.015	0.019	1	0.381	0.482
C	0.003	0.006	1	0.077	0.152
e	0.050 TP		2	1.27 TP	
E	0.200	0.300		5.1	7.6
H	0.600	1.000		15.3	25.4
L	0.150	0.350		3.9	8.8
N	14		3	14	
Q	0.005	0.050		0.13	1.27
S	0.000	0.050		0.00	1.27
Z	0.300		4	7.62	
Z_1	0.400		4	10.16	

92SS-4300R3

NOTES:
1. Refer to JEDEC Publication No. 95 for Rules for Dimensioning Peripheral Lead Outlines.
2. Leads within 0.005" (0.12 mm) radius of True Position (TP) at maximum material condition.
3. N is the maximum quantity of lead positions.
4. Z and Z_1 determine a zone within which all body and lead irregularities lie.

(K) SUFFIX (JEDEC MO-004-AG)
16-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.008	0.100		0.21	2.54
B	0.015	0.019	1	0.381	0.482
C	0.003	0.006	1	0.077	0.152
e	0.050 TP		2	1.27 TP	
E	0.200	0.300		5.1	7.6
H	0.600	1.000		15.3	25.4
L	0.150	0.350		3.9	8.8
N	16		3	16	
Q	0.005	0.050		0.13	1.27
S	0.000	0.025		0.00	0.63
Z	0.300		4	7.62	
Z_1	0.400		4	10.16	

92CS-17271R3

(K) SUFFIX
24-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.075	0.120		1.91	3.04
B	0.018	0.022	1	0.458	0.558
C	0.004	0.007	1	0.102	0.177
e	0.050 TP		2	1.27 TP	
E	0.600	0.700		15.24	17.78
H	1.150	1.350		29.21	34.29
L	0.225	0.325		5.72	8.25
N	24		3	24	
Q	0.035	0.070		0.89	1.77
S	0.060	0.110	1	1.53	2.79
Z	0.700		4	17.78	
Z_1	0.750		4	19.05	

92CS-19949R2

(K) SUFFIX
28-Lead

SYMBOL	INCHES		NOTE	MILLIMETERS	
	MIN.	MAX.		MIN.	MAX.
A	0.075	0.120		1.91	3.04
B	0.018	0.022	1	0.458	0.558
C	0.004	0.007	1	0.102	0.177
e	0.050 TP		2	1.27 TP	
E	0.600	0.700		15.24	17.78
H	1.150	1.350		29.21	34.29
L	0.225	0.325		5.72	8.25
N	28		3	28	
Q	0.035	0.070		0.89	1.77
S	0	0.060	1	0	1.53
Z	0.700		4	17.78	
Z_1	0.750		4	19.05	

92CS-20972